

# *Next-Generation GaN power ICs Drive Transformer Revolution*

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# Apple Power Adapter Family

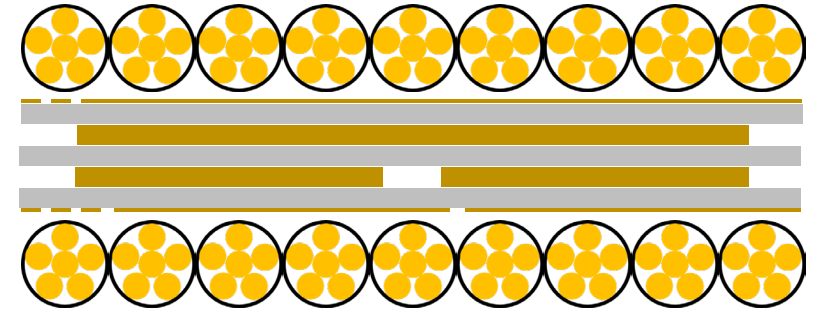
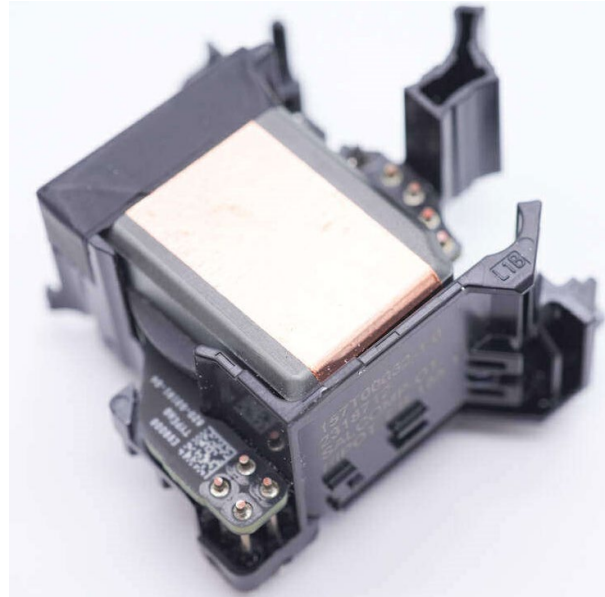




# State-of-the-Art 70W Adapter -- Apple



**65 x 65 x 28.6 mm**



Pri:Sec:Aux1:Aux2=18:3:2:6

Pri winding: 0.13 x 6, DCR=360mohm

Sec winding: 8oz, DCR=6.8mohm

- Pros:**
- ✓ Low DCR
  - ✓ Low fringing loss
  - ✓ EMI consistency

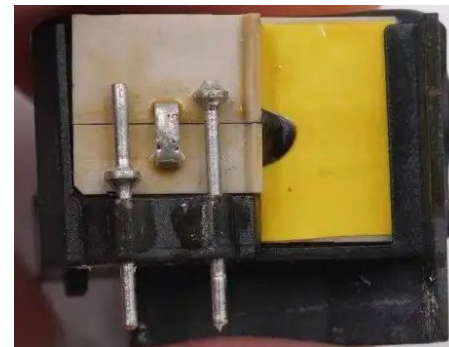
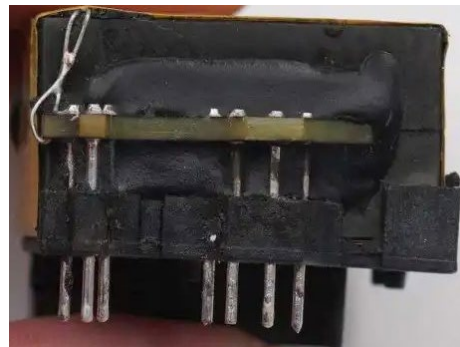
- Cons:**
- ❖ High cost PCB and wire
  - ❖ Complicated manufacturing



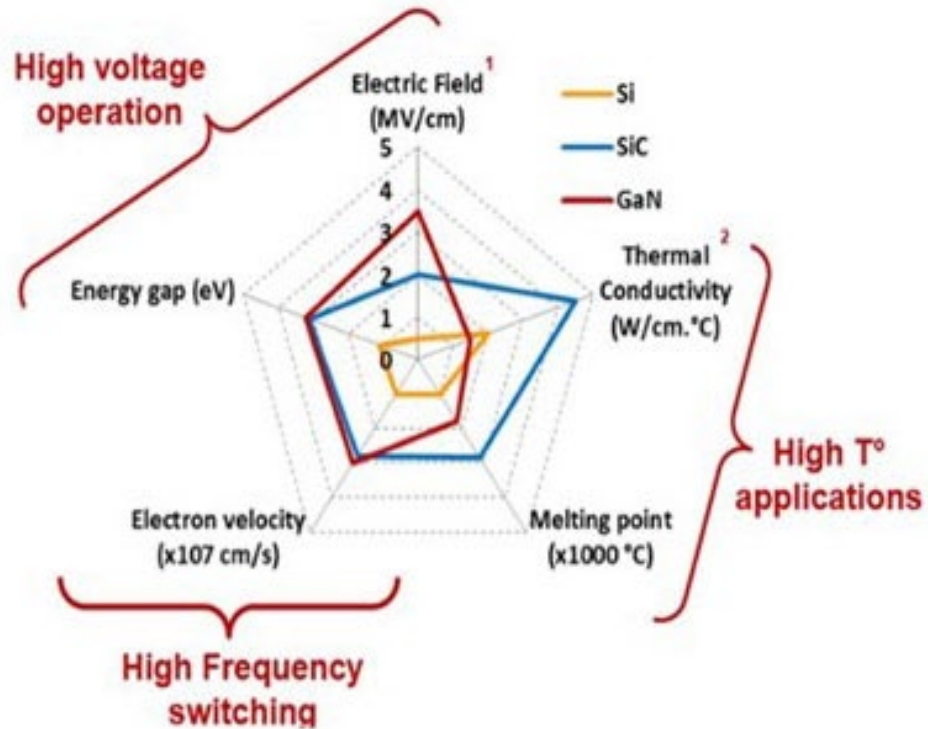
- Pros:**
- ✓ Low DCR
  - ✓ EMI consistency
  - ✓ Small footprint

- Cons:**
- ❖ High cost Cu plate and tooling
  - ❖ Complicated manufacturing

47.7 x 43.6 x 28 mm



➤ Pick same  $R_{ds}$  device, GaN has 10X smaller die size



Parameters	Si CoolMOS	NV6136
$V_{DS}$ (V)	650	700
$R_{DS}$ ( $\Omega$ )	0.17	0.17
$Q_g$ (nC)	23	2.4
$C_{OSS\_tr}$ (pF)	374	36
$Q_{rr}+Q_{COSS}$ (nC)	5950	16
$E_{off}$ @ 5A ( $\mu$ J)	> 2	<0.2

# Benefits of Integrated GaN Power ICs

## Gate Driver

Drive, control and protection

## Parasitic

Limitation of switching speed and efficiency

## Power Device

Si / GaN

## Frequency

Switching frequency

## Power Density

Smaller volume, faster charging speed

Discrete Si MOSFET



(Included in controllers)

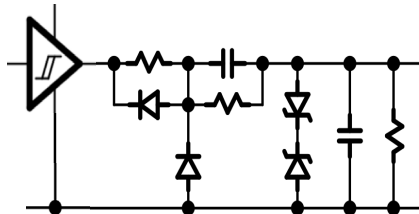


< 100 kHz

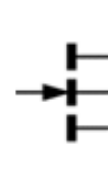


< 0.5 W/cc

Discrete GaN Device



(EZ Drive)

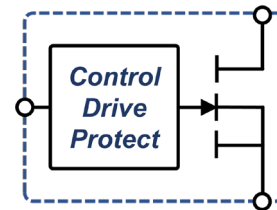


< 200 kHz



< 1 W/cc

Navitas  
Integrated  
GaN Power  
IC

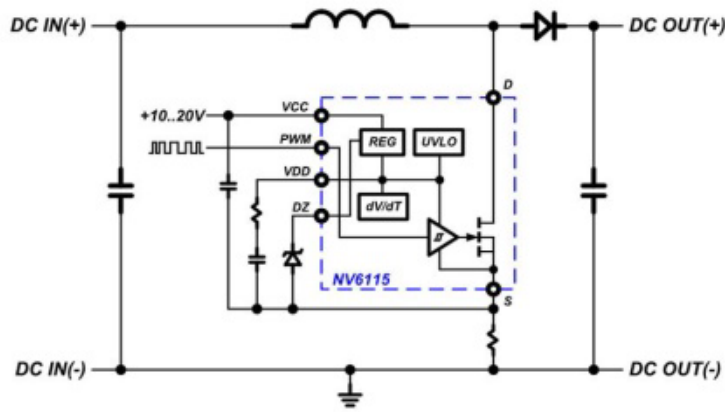


Up to 2 MHz



>> 1 W/cc



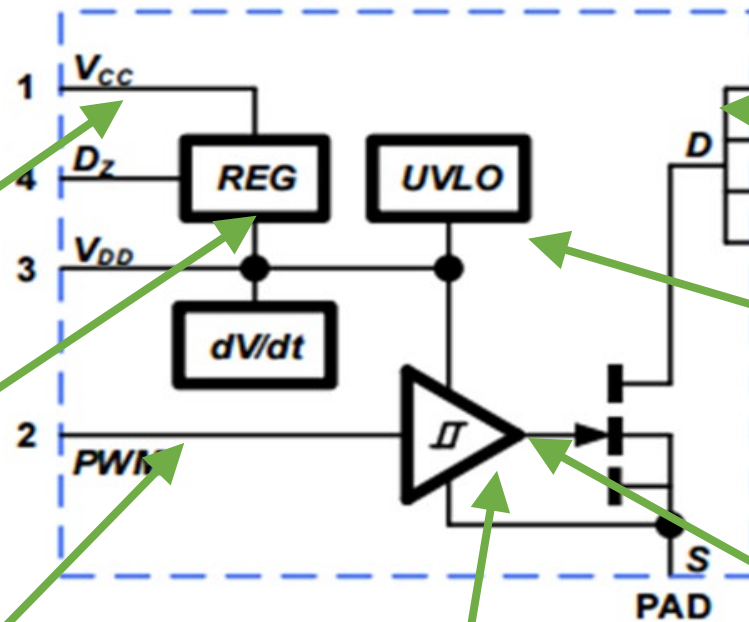


Integrated driver → **Simple and reliable**

Wide VCC range  
(10-30V)

The regulator ensures  
that the  $V_{GS}$  is within the  
SOA range

PWM hysteresis can  
suppresses the noise

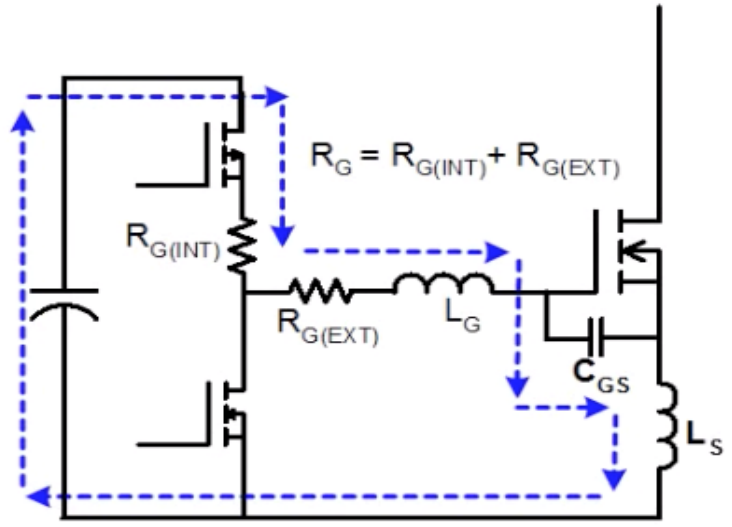


Layout is simple and flexible

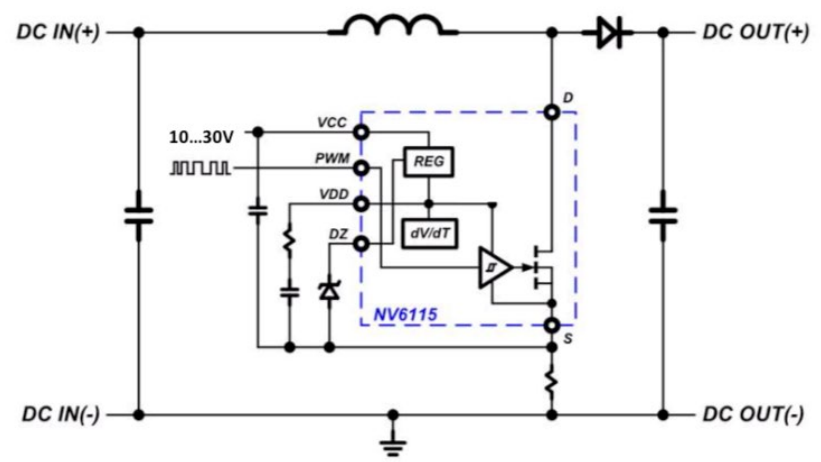
Undervoltage lockout protects  
the driver and GaN FET even  
the  $V_{CC}$  is not fully charged up

The gate is protected from  
external noises

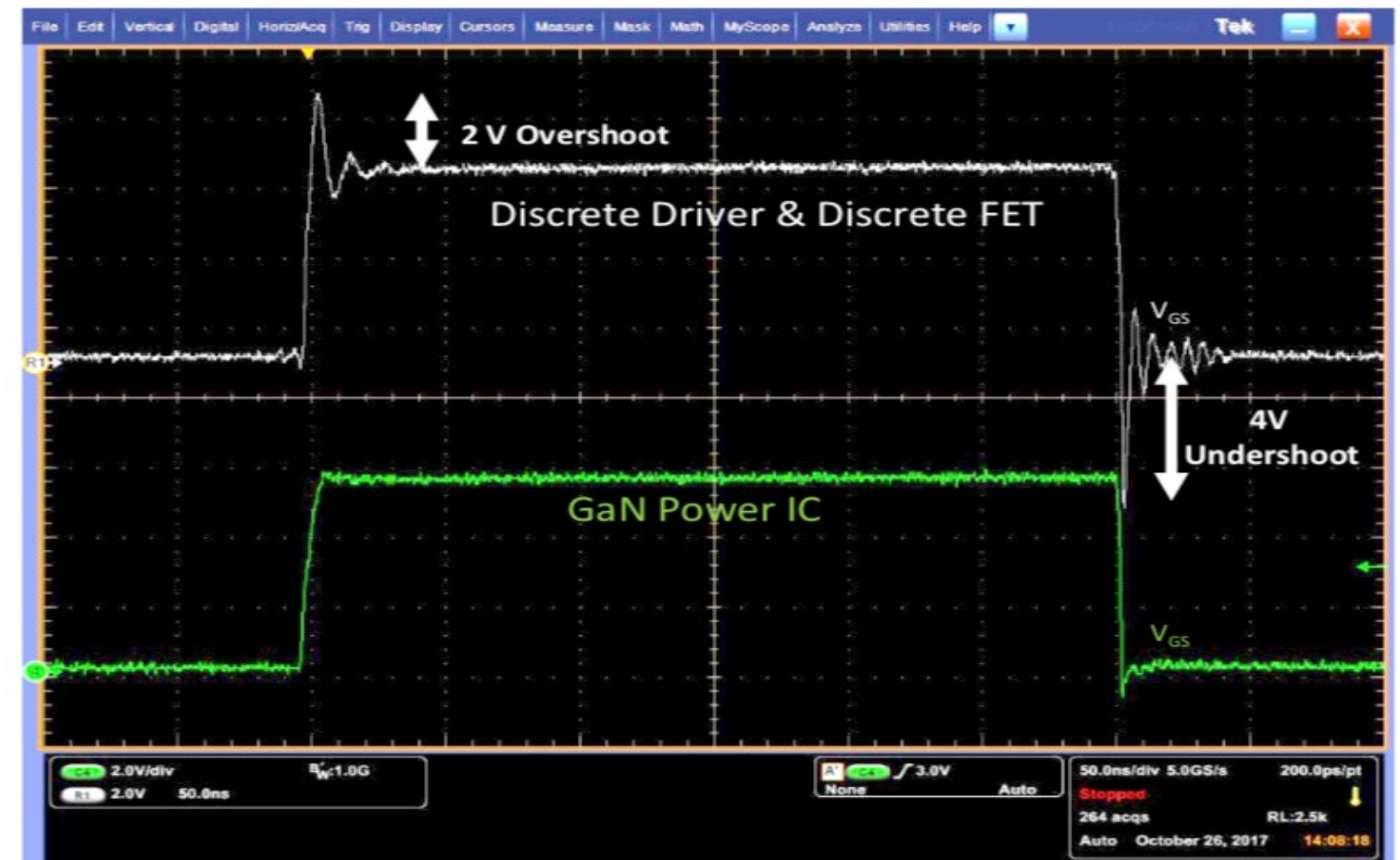
No parasitic inductance or  
ringing in the gate driving loop



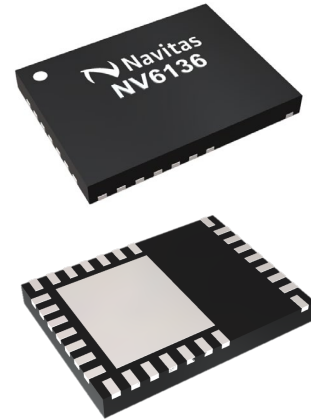
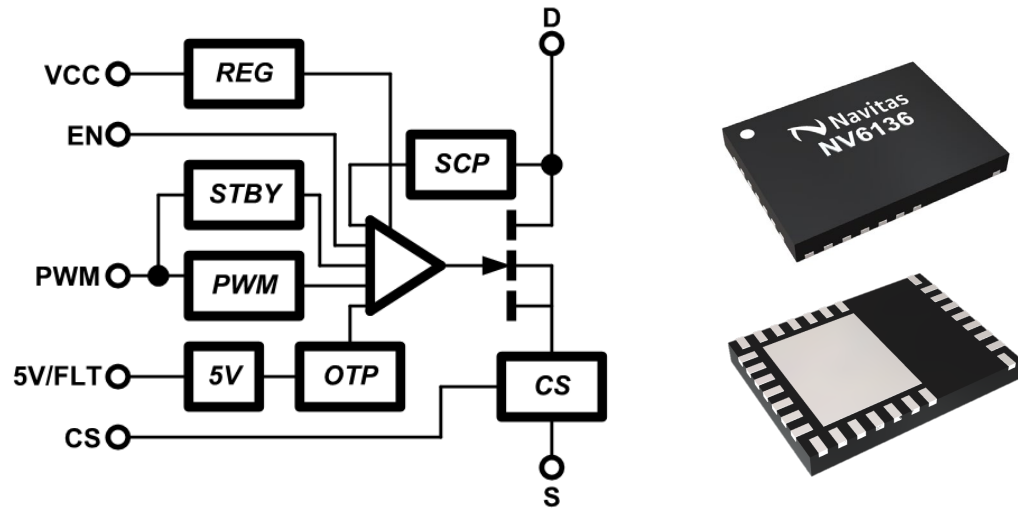
Discrete GaN: direct drive



NV GaN: integrated drive

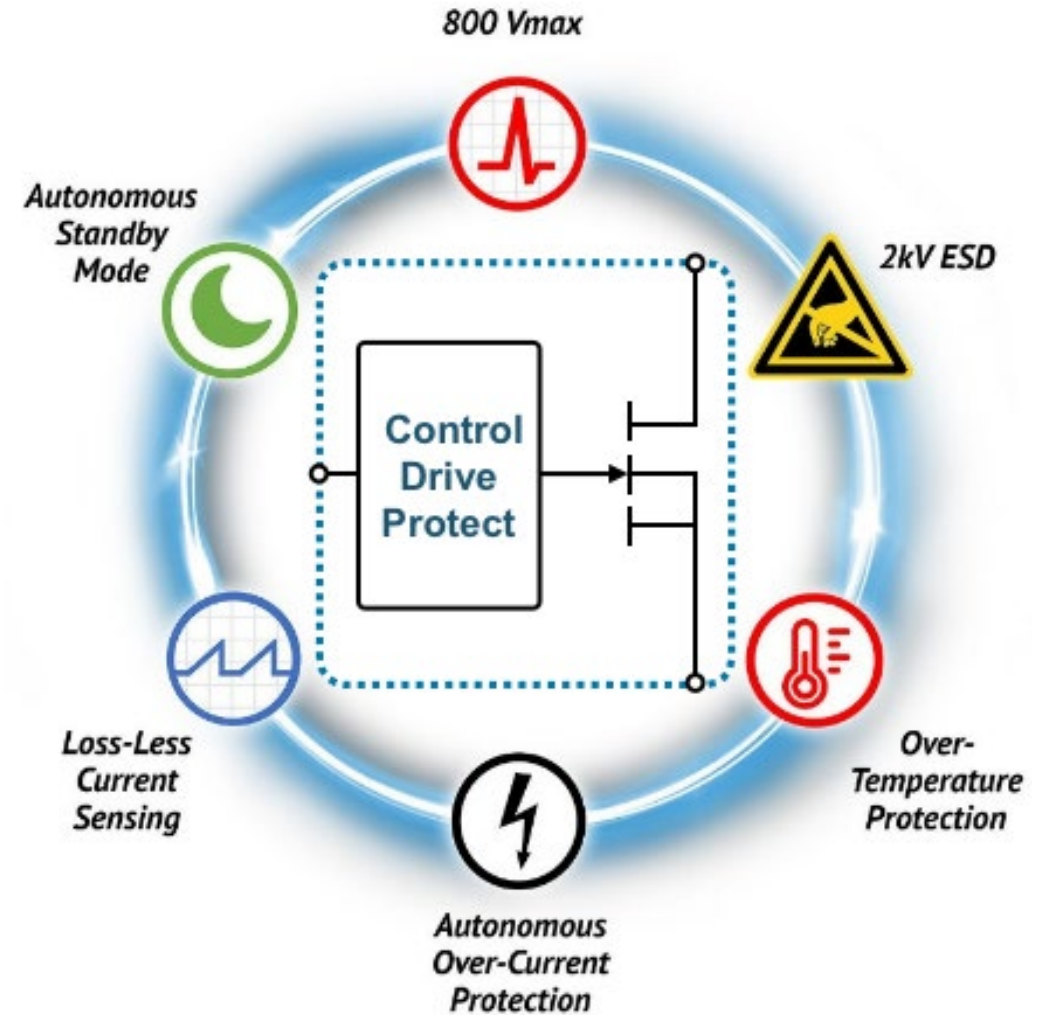






- GaN Sense™ Technology**
- **Fast**
  - **Autonomous**
  - **Self-driven**
  - **Real-time sensing**
  - **Self-protected**
  - **Precision**
  - **Flexible**

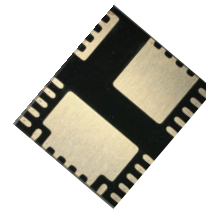
- Increased Integration**
- **Enable input**
  - **5V aux output**
  - **dV/dt control**
  - **Integrated gate drive**
  - **Integrated regulator**



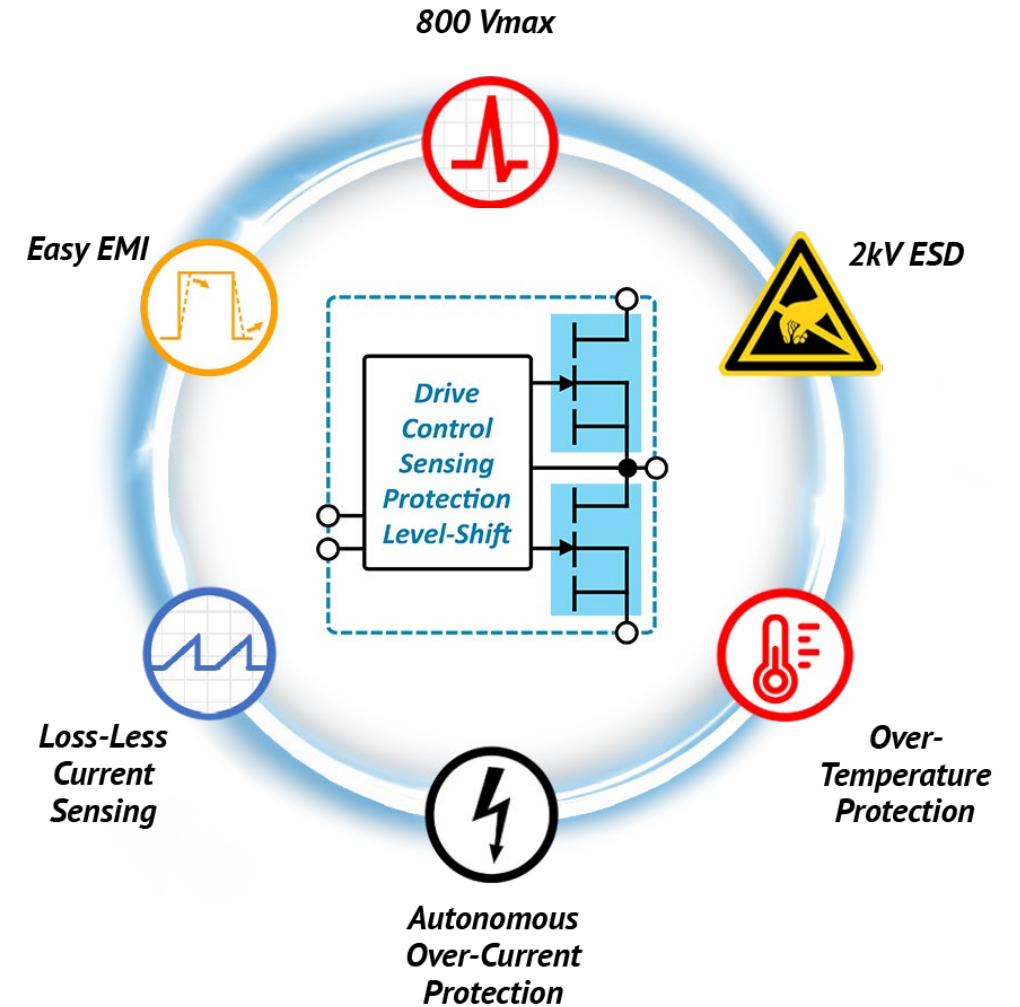
**GaNSense  
Half-Bridge**



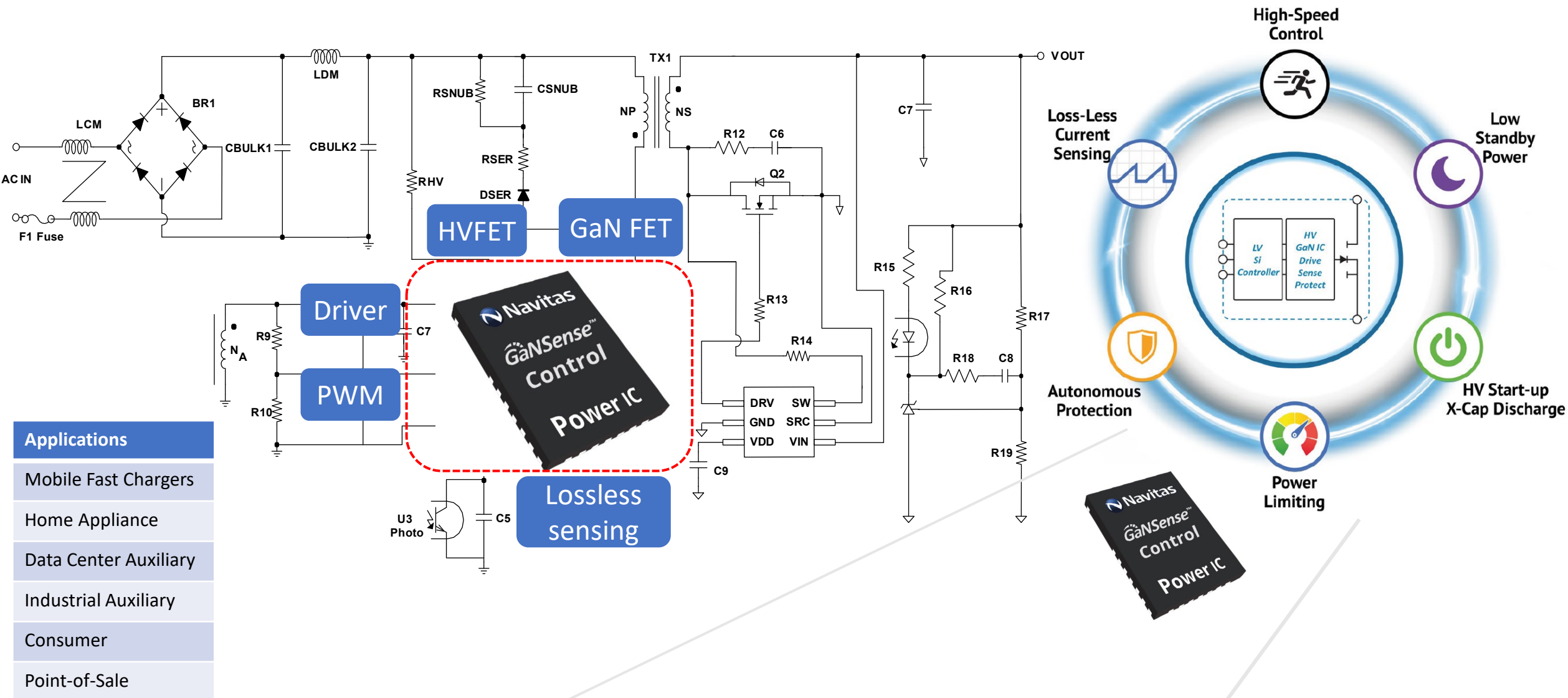
**Smart dv/dt  
technology**



- ✓ Highest integration
  - ✓ integrated HS and LS FETs
  - ✓ Integrated level-shift isolation
  - ✓ integrated boot-strap
  - ✓ Shoot-through protection
  - ✓ Enlarged cooling pads
- ✓ Fastest switching
- ✓ Highest efficiency



# GaNSense Control: PWM + GaN Integration

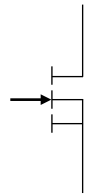


## Applications

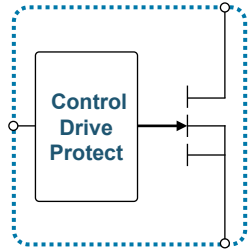
- Mobile Fast Chargers
- Home Appliance
- Data Center Auxiliary
- Industrial Auxiliary
- Consumer
- Point-of-Sale



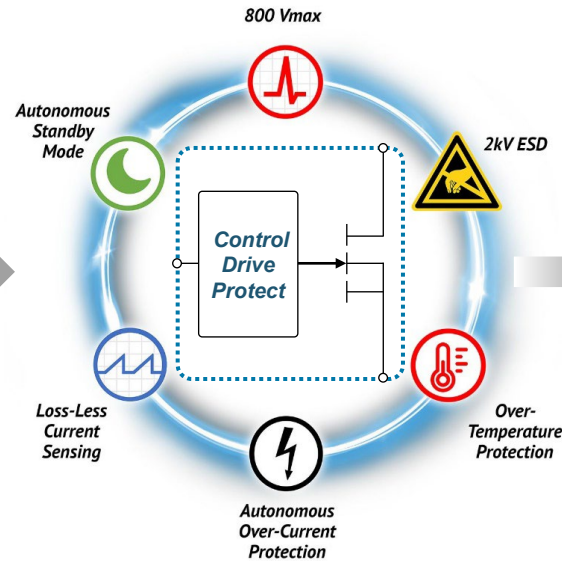
Discrete GaN



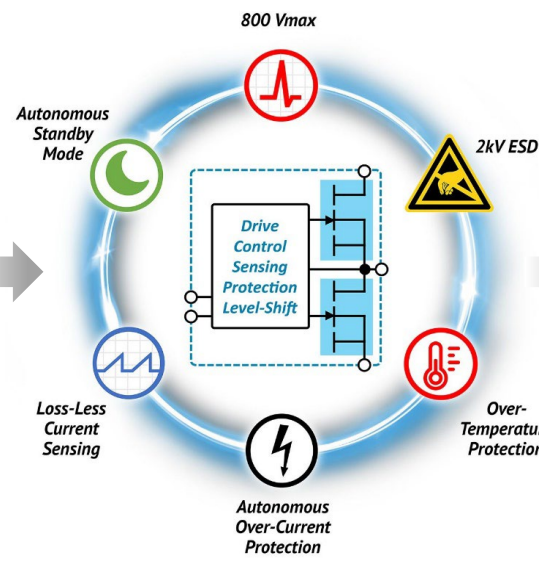
GaNFast™



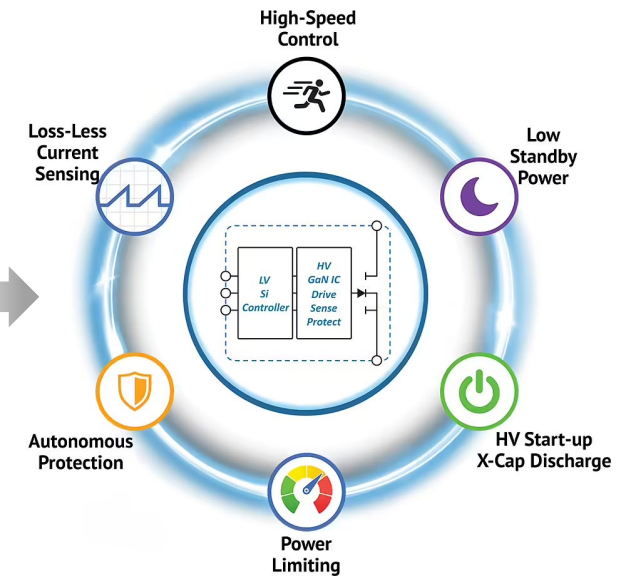
GaNSense™



GaNSense Half-Bridge



GaNSense Control



- Vulnerable
- Difficult to use
- Unknown reliability

- ✓ Robust
- ✓ Easy to use
- ✓ Proven reliability

- GaNFast plus:*
- ✓ Autonomous protection
  - ✓ Loss-less current sensing

- GaNSense plus:*
- ✓ Integrated HS, LS, level-shift isolation
  - ✓ Complete protection

- GaNSense plus:*
- ✓ LV silicon system controller
  - ✓ Fewest components

Efficiency

Reliability

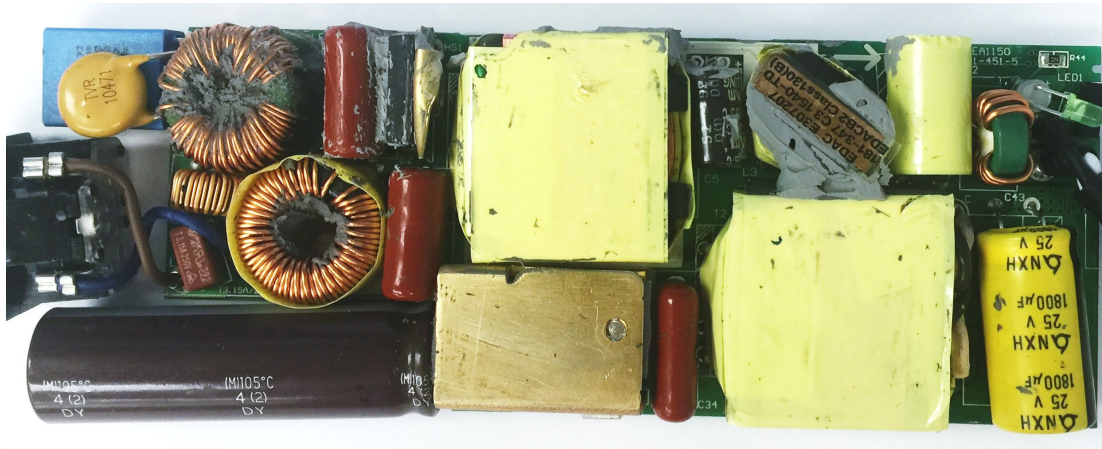
Speed

Integration

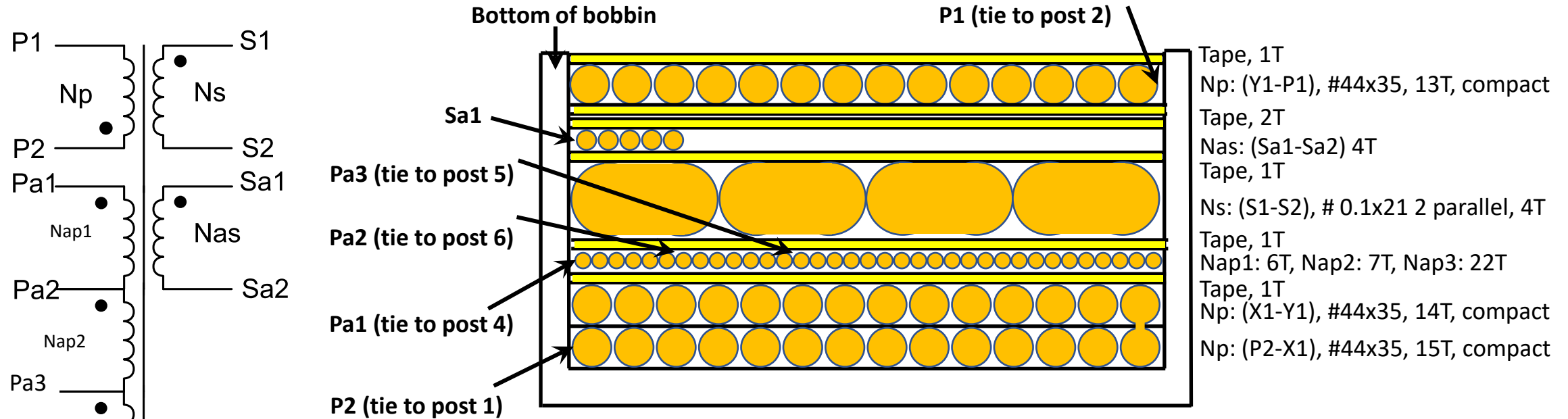
Apple61W



Razor 120W



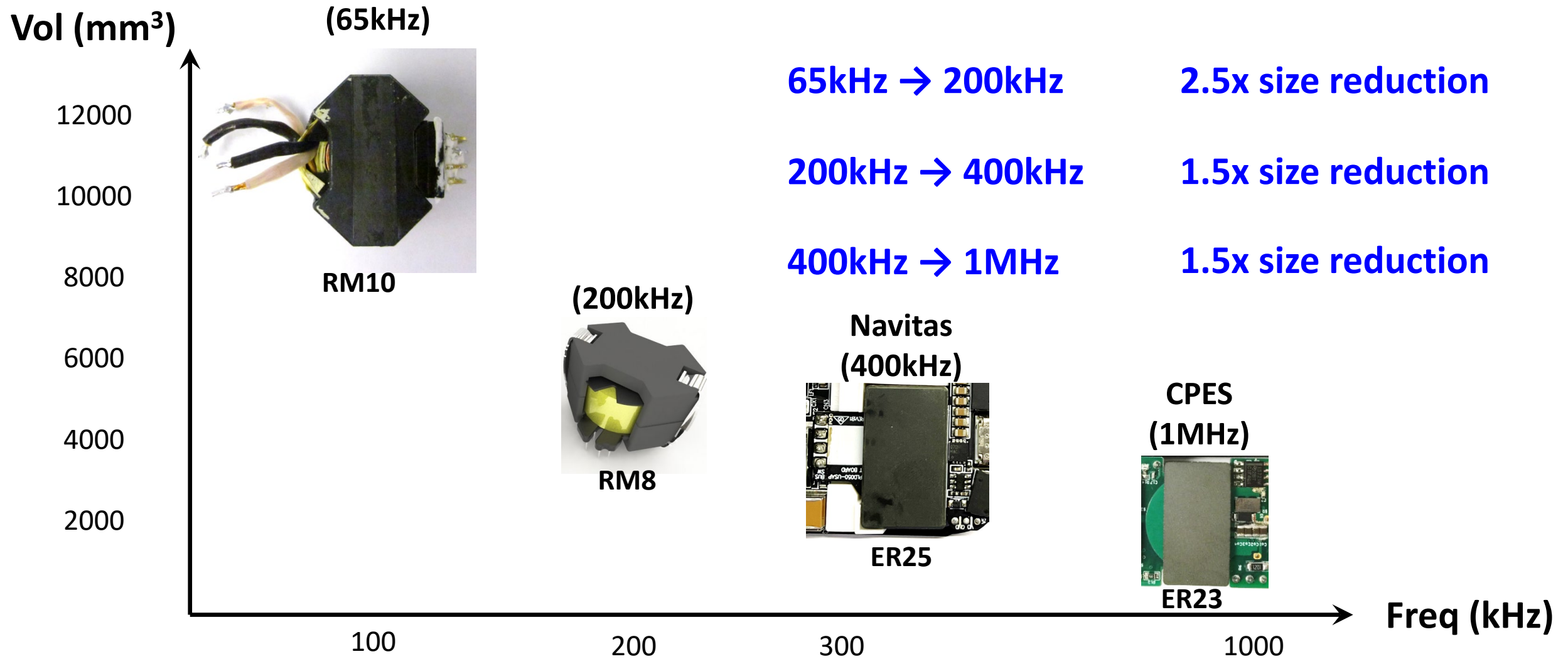
# Complicated Structure of Bobbin Transformer

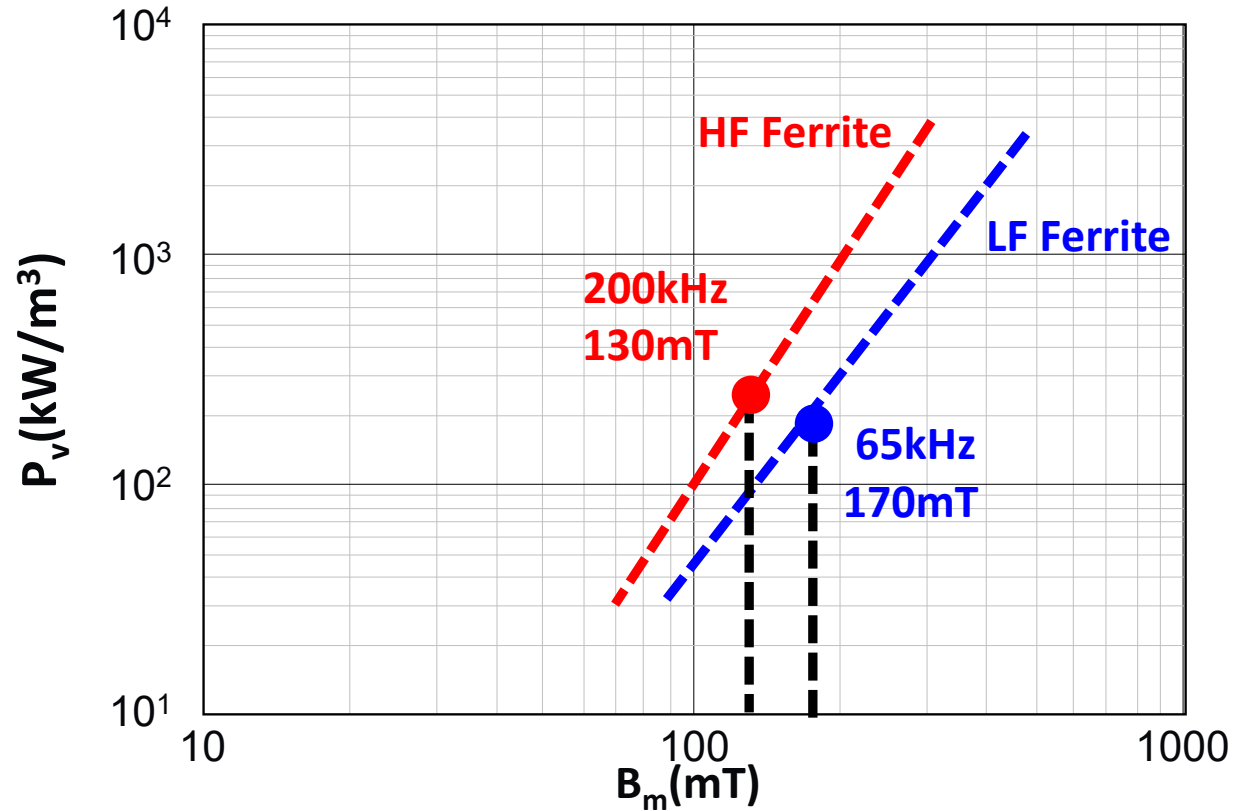


Parameters	Wire
Primary main (Np)	Litz #44 x 35
Secondary main (Ns)	Triple insulated Litz 0.1 x 21 2 in parallel
Primary Aux (Nap1 & Nap2)	Solid wire AWG 36
Secondary Aux (Nas)	Triple insulated wire Thinner than AWG 34



# GaN IC Enables High Frequency Planar TX





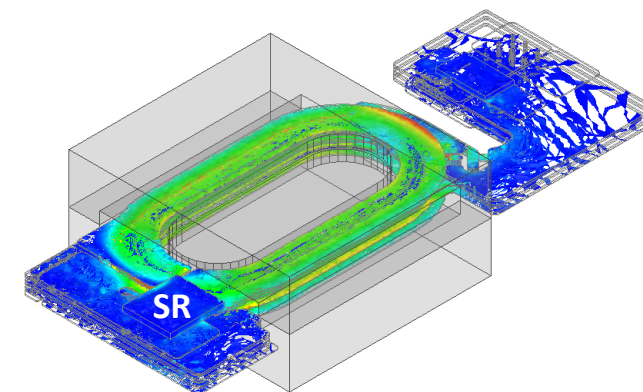
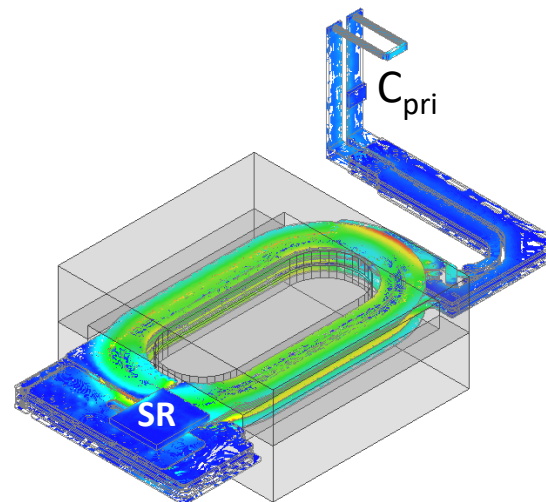
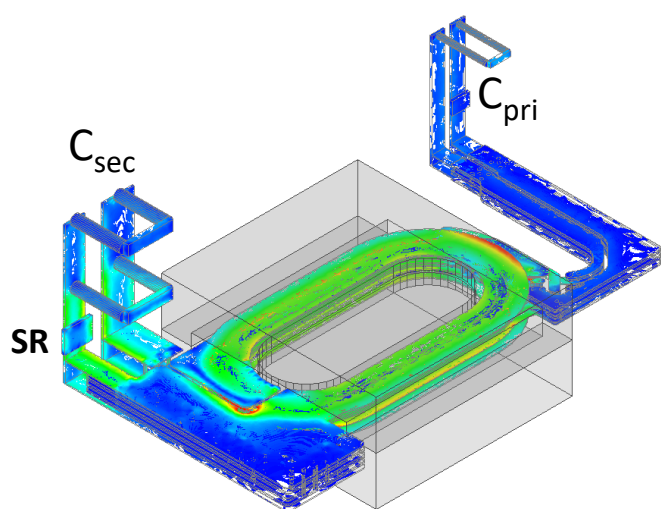
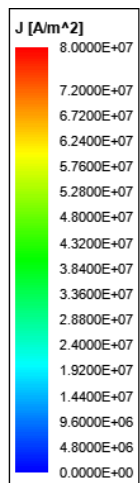
$$u = \frac{N_S \cdot Ae \cdot B_{pk-pk}}{\Delta t}$$

$$\underline{\underline{N_S \cdot Ae}} = \frac{V_O \cdot (1 - D)}{2 \cdot \Delta B \cdot f_s}$$

Transformer  
volume

$N_S \cdot Ae$ : **2.4x** Reduction

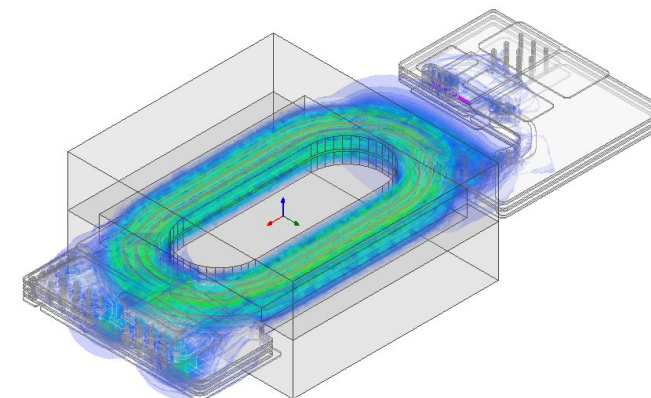
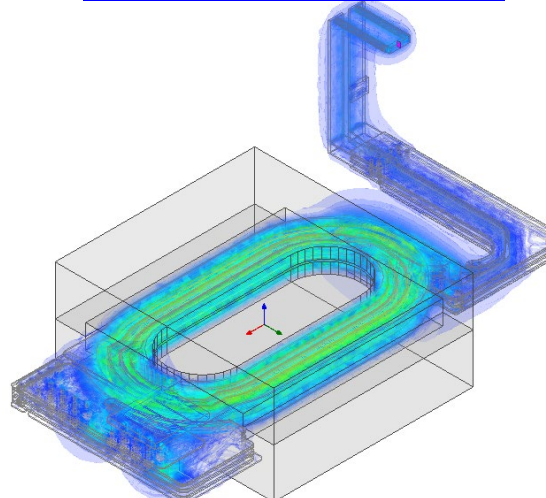
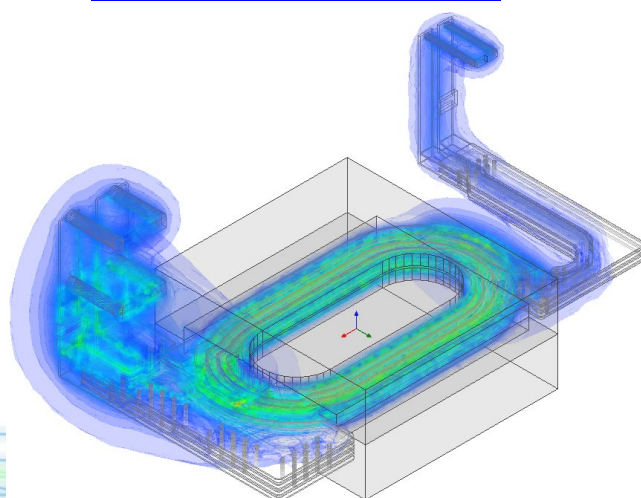
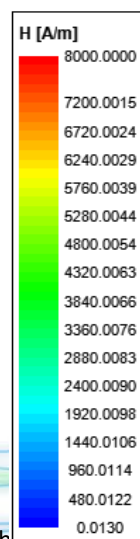
# Integrated Power Devices onto PCB Winding



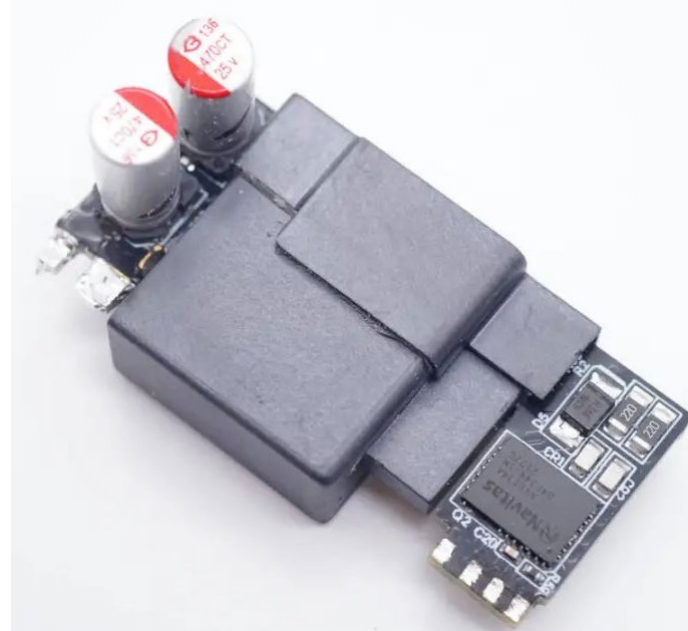
➤  $L_k$ : 2.6uH  
➤  $P_{Winding}$ : 1.8W

➤  $L_k$ : 1.9uH  
➤  $P_{Winding}$ : 1.2W

➤  $L_k$ : 1.8uH  
➤  $P_{Winding}$ : 1.1W







- ✓ Lowest voltage stress on both primary and secondary switches
- ✓ Lowest switching noise across the PCB board
- ✓ Highest efficiency and manufacturability

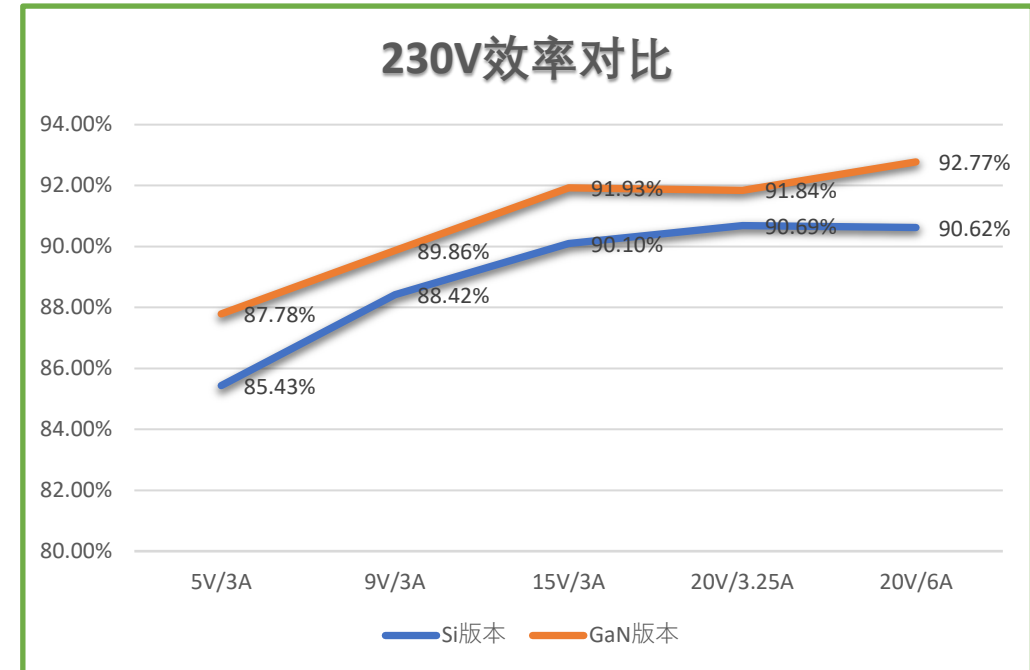
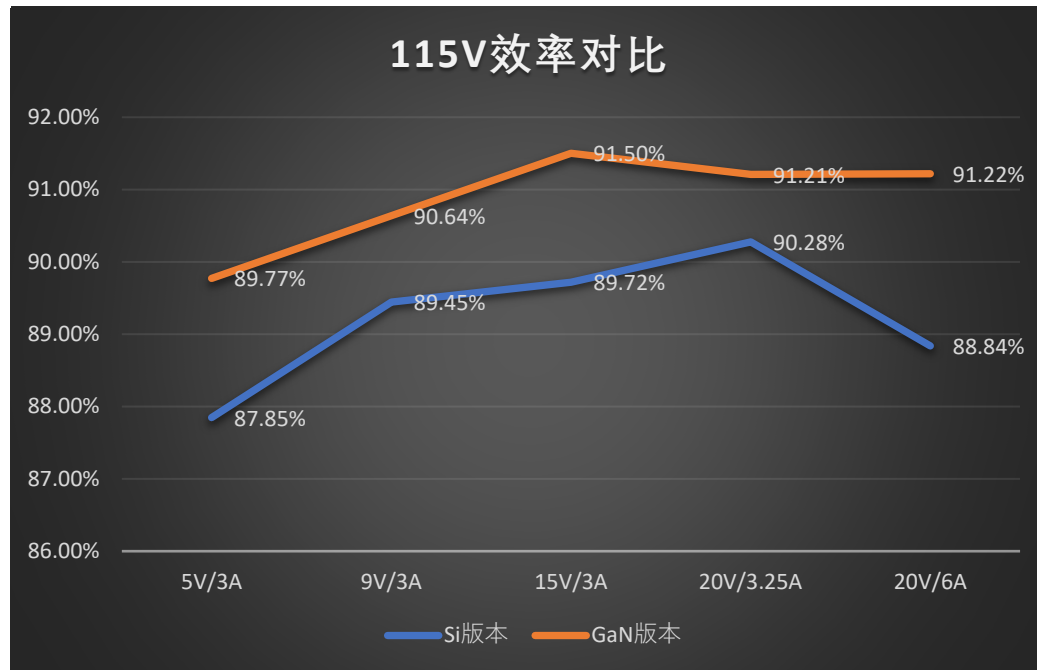
## GaN



## Si



	GaN	Si
Case size	55.59*55.67*28.35mm	63.54*60.36*28.22mm
Power Density	1.36W/cm <sup>3</sup>	1.11W/cm <sup>3</sup>

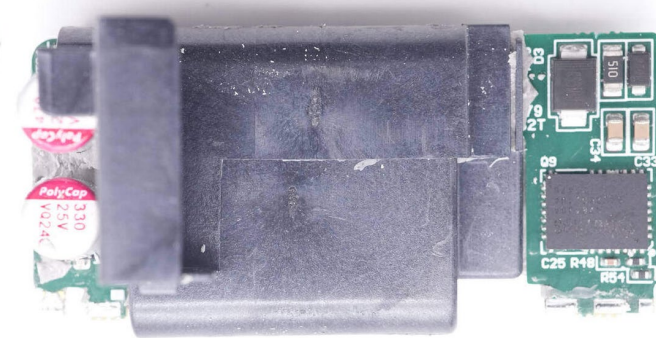


- ✓ Lower case temp rise
- ✓ Shorter 0-100% battery charging time
- ✓ Power saving  $5 \times 10^{-4}$  kWh per charge assuming 5000mA battery

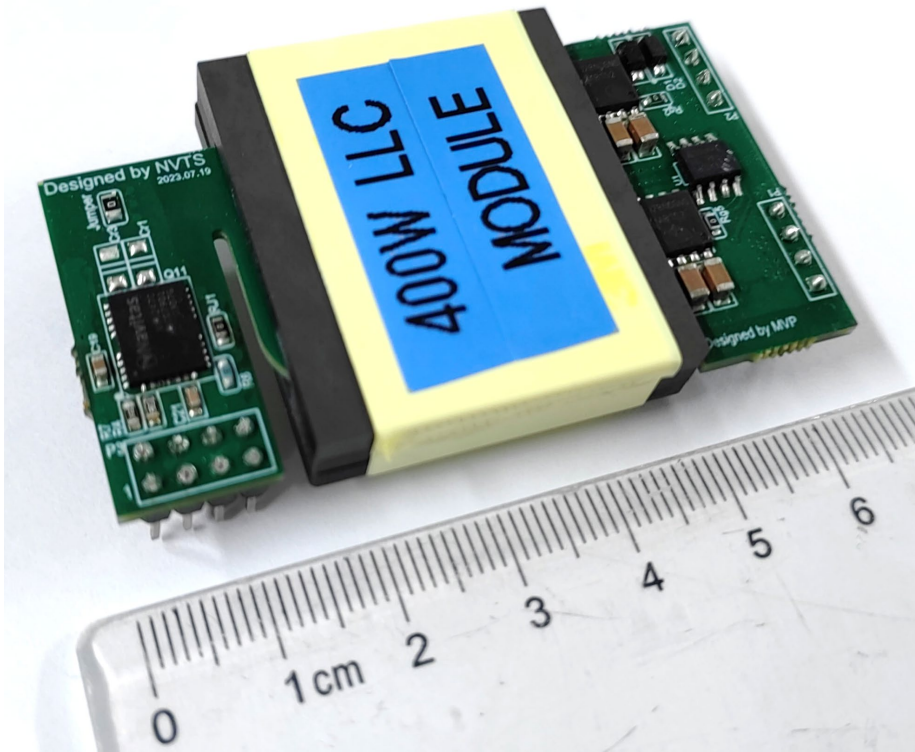


**240W SUPERVOOC™**  
**超级闪充**

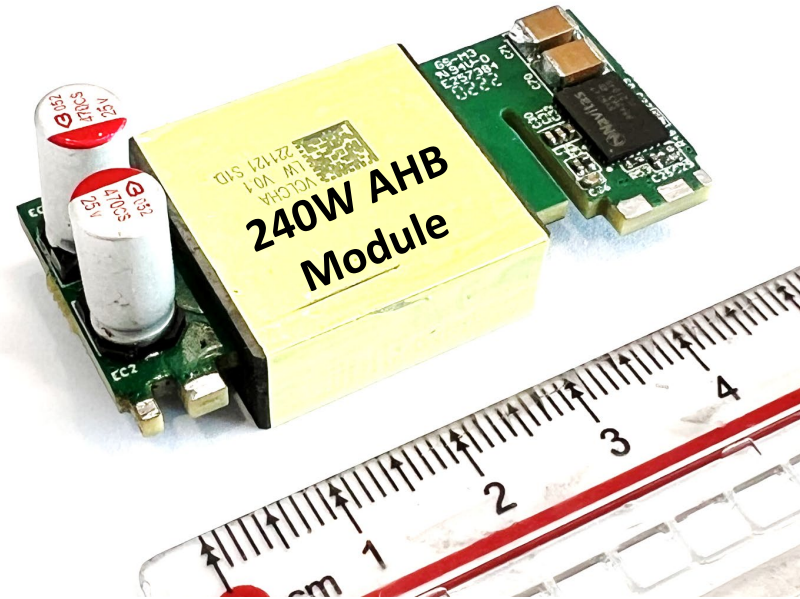
9分钟充至100%  
等效4500mAh电池



$F_s=500\text{kHz}$



$F_s=300\text{kHz}$





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